

FCH077N65F F085

N-Channel SuperFET II FRFET MOSFET

650 V, 54 A, 77 mΩ

Features

- Typical $R_{DS(on)}$ = 68 m Ω at V_{GS} = 10 V, I_D = 27 A
- Typical Q_{q(tot)} = 126 nC at V_{GS} = 10V, I_D = 27 A
- UIS Capability
- Qualified to AEC Q101
- RoHS Compliant

Description

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SuperFETII is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC-DC, Interleaved Boost PFC, Boost PFC for HEV-EV automotive.

SuperFET II FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

Maximum Ratings T_C = 25°C unless otherwise noted



For current package drawing, please refer to the Fairchild website at https://www.fairchildsemi.com/package-drawings/TO/ TO247A03.pdf

Application

- Automotive On Board Charger
- Automotive DC/DC converter for HEV



December 2014 FCH077N65F_F085 N-Channel SuperFET II FRFET MOSFET

Symbol	Paramete	er	Ratings	Units	
V _{DSS}	Drain to Source Voltage	650	V		
V _{GS}	Gate to Source Voltage		±20	V	
	Drain Current - Continuous (V _{GS} =10) (Ne	ote 1)	54	Α	
D	Pulsed Drain Current		See Fig 4	Α	
E _{AS}	Single Pulse Avalanche Rating	(Note 2)	1128	mJ	
مار ، الم	MOSFET dv/dt		100	V/ns	
av/at	Peak Diode Recovery dv/dt	(Note 3)	50		
D	Power Dissipation		481	W	
PD	Derate Above 25°C		3.85	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature	-55 to + 150	°C		
$R_{\theta JC}$	Maximum Thermal Resistance Junction to	o Case	0.26	°C/W	
R _{0.IA}	Maximum Thermal Resistance Junction to	o Ambient (Note 4)	40	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH077N65F	FCH077N65F_F085	TO-247	-	-	30

Notes:

1: Current is limited by bondwire configuration.

2: Starting $T_J = 25^{\circ}C$, L = 18.65mH, $I_{AS} = 11A$, $V_{DD} = 100V$ during inductor charging and $V_{DD} = 0V$ during time in avalanche. 3: $I_{SD} \le 27A$, di/dt ≤ 200 A/us, $V_{DD} \le 380V$, starting $T_J = 25^{\circ}C$.

4: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA}is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Symbol	Parameter	Test	Conditions	Min	Тур	Мах	Units
Off Cha	racteristics	I	I				
B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V		650	-	-	V
	Drain to Course Lookage Current	V _{DS} =650V,	$T_J = 25^{\circ}C$	-	-	10	μA
DSS	Dialitito Source Leakage Current	$V_{GS} = 0V$	T _J = 150 ^o C(Note 5)	-	-	1	mA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$		3.0	-	5.0	V
On Cha	racteristics						
r _{DS(on)}	Drain to Source On Resistance	I _D = 27A, V _{GS} = 10V	$T_J = 25^{\circ}C$ $T_J = 150^{\circ}C(Note 5)$	-	68 154	77 184	mΩ mΩ
Dynami	c Characteristics				5385	7162	pF
	Output Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		-	5629	7486	pF
C _{rss}	Reverse Transfer Capacitance			-	194	-	pF
C _{oss(eff)}	Effective Output Capacitance	$V_{DS} = 0V$ to 520V, $V_{GS} = 0V$		-	693	-	pF
R _a	Gate Resistance	f = 1MHz		-	0.5	-	Ω
Q _{q(ToT)}	Total Gate Charge	$V_{DD} = 380V$ $I_{D} = 27A$ $V_{GS} = 10V$		-	126	164	nC
Q _{g(th)}	Threshold Gate Charge			-	9	12	nC
Q _{gs}	Gate to Source Gate Charge			-	28	-	nC
Q _{ad}	Gate to Drain "Miller" Charge			-	53	-	nC

Switching Characteristics

t _{on}	Turn-On Time		-	64	148	ns
t _{d(on)}	Turn-On Delay Time		-	37	-	ns
t _r	Rise Time	V _{DD} = 380V, I _D = 27A,	-	27	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10V, R _G = 4.7Ω	-	105	-	ns
t _f	Fall Time		-	5.3	-	ns
t _{off}	Turn-Off Time		-	108.3	237	ns

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	I _{SD} = 27A, V _{GS} = 0V	-	-	1.2	V
T _{rr}	Reverse Recovery Time	I _F = 27A, dI _{SD} /dt = 100A/μs	-	190	-	ns
Q _{rr}	Reverse Recovery Charge	V _{DD} = 520V	-	1.5	-	μC

Notes:

5: The maximum value is specified by design at T_J = 150°C. Product is not tested to this condition in production.



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FCH077N65F_F085 Rev. B1

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